



CHENMKO ENTERPRISE CO.,LTD

CHT2302PT

SURFACE MOUNT

N-Channel Enhancement Mode Field Effect Transistor

VOLTAGE 20 Volts CURRENT 2.8 Ampere

Lead free devices

APPLICATION

- * Servo motor control.
- * Power MOSFET gate drivers.
- * Other switching applications.

FEATURE

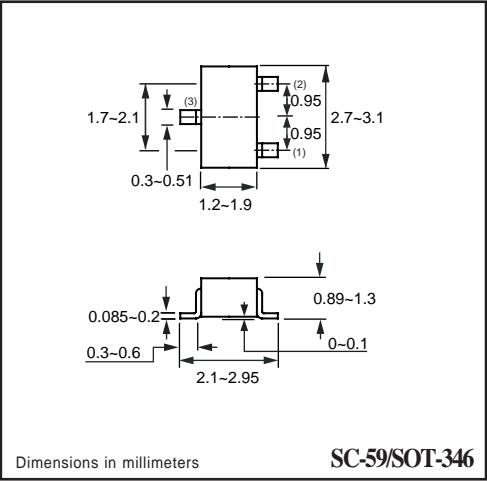
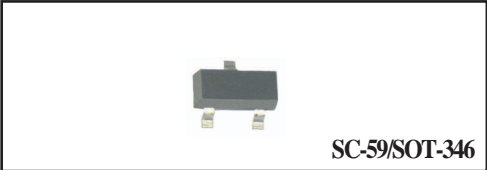
- * Small surface mounting type. (SC-59/SOT-346)
- * High density cell design for low R_{DS(ON)}.
- * Suitable for high packing density.
- * Rugged and reliable.
- * High saturation current capability.
- * Voltage controlled small signal switch.

CONSTRUCTION

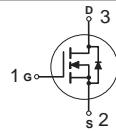
- * N-Channel Enhancement

MARKING

* 02



CIRCUIT



Absolute Maximum Ratings T_A = 25°C unless otherwise noted

Symbol	Parameter	CHT2302PT	Units
V _{DSS}	Drain-Source Voltage	20	V
V _{GSS}	Gate-Source Voltage	±8	V
I _D	Maximum Drain Current - Continuous (Note 1)	2.8	A
	- Pulsed (Note 2)	10	
I _S	Drain-Source Diode Forward Current (Note 1)	1.6	A
P _D	Maximum Power Dissipation (Note 1)	1250	mW
T _J , T _{STG}	Operating and Storage Temperature Range	-55 to 150	°C

Note : 1. Surface Mounted on FR4 Board , t <= 10sec
 2. Pulse Test , Pulse width <= 300us , Duty Cycle <= 2%

Thermal characteristics

R _{θJA}	Thermal Resistance, Junction-to-Ambient	85	°C/W
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RATING CHARACTERISTIC CURVES (CHT2302PT)

Electrical Characteristics $T_A = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Conditions	Min	Typ	Max	Units
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OFF CHARACTERISTICS

BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} = 0 V, I _D = 250 μA	20			V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 16 V, V _{GS} = 0 V			1	μA
I _{GSS}	Gate-Body Leakage	V _{GS} = 8 V, V _{DS} = 0 V			+100	nA
I _{GSS}	Gate-Body Leakage	V _{GS} = -8 V, V _{DS} = 0 V			-100	nA

ON CHARACTERISTICS (Note 2)

V _{GS(th)}	Gate Threshold Voltage	V _{DS} = V _{GS} , I _D = 250 μA	0.7		1.2	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} =4.5V, I _D =3.6A			85	mΩ
		V _{GS} =2.5V, I _D =3.1A			115	
V _{SD}	Diode Forward Voltage	V _{DS} = V _{GS} , I _D = -250 μA			1.0	V

SWITCHING CHARACTERISTICS (Note 3)

Q _g	Total Gate Charge	V _{DS} =10V, I _D =1A V _{GS} =4.5V		6.52		nC
Q _{gs}	Gate-Source Charge			1.6		
Q _{gd}	Gate-Drain Charge			1.16		
t _{on}	Turn-On Time	V _{DD} = 10V I _D = 1.0A, V _{GEN} = 4.5 V R _L = 10 Ω , R _{GEN} = 10 Ω		12		nS
t _r	Rise Time			36		
t _{off}	Turn-Off Time			34		
t _f	Fall Time			10		

Note : 3. Guaranteed by design , not subject to production trsting

RATING CHARACTERISTIC CURVES (CHT2302PT)

Typical Electrical Characteristics

Figure 1. Output Characteristics

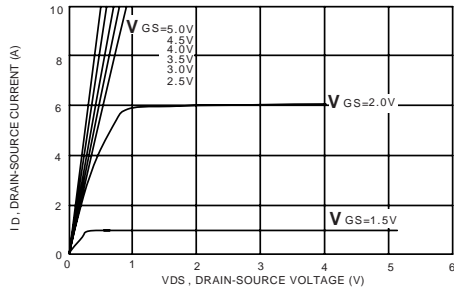


Figure 2. Transfer Characteristics

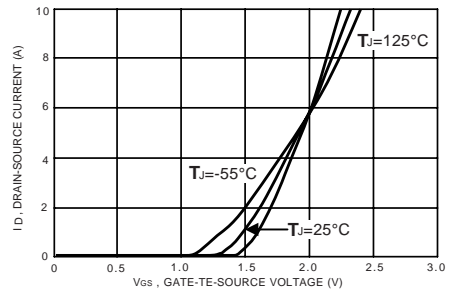


Figure 3. Breakdown Voltage Variation with Temperature

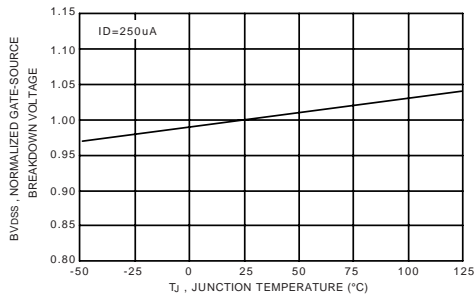


Figure 4. On-Resistance Variation with Temperature

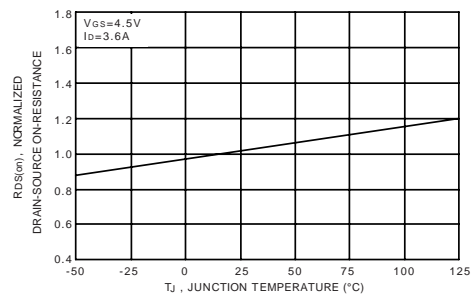


Figure 5. Gate Threshold Variation with Temperature

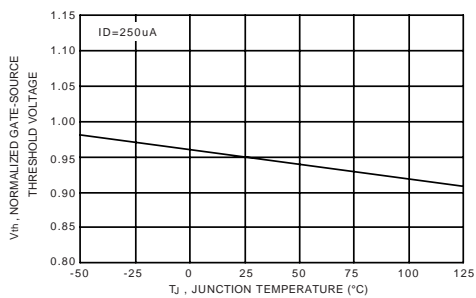


Figure 6. Gate Charge

